

Title (en)
METHOD FOR HYDROPHILIC MODIFICATION OF A SUBSTRATE USING A TREATMENT IN AN AQUEOUS MEDIUM WITH A WATER SOLUBLE AND HEAT-SENSITIVE POLYMER

Title (de)
VERFAHREN ZUR HYDROPHILEN VERÄNDERUNG EINES SUBSTRATES DURCH BEHANDLUNG IN WÄSSRIGEM MILIEU MIT EINEM WASSERLÖSLICHEN, WÄRMEEMPFINDLICHEN POLYMEREN

Title (fr)
PROCEDE DE MODIFICATION HYDROPHILE D'UN SUBSTRAT METTANT EN JEU UN TRAITEMENT EN MILIEU AQUEUX PAR UN POLYMERE SOLUBLE DANS L'EAU ET THERMOSENSIBLE

Publication
EP 1412097 A1 20040428 (FR)

Application
EP 01921523 A 20010409

Priority
• FR 0101075 W 20010409
• FR 0004695 A 20000412

Abstract (en)
[origin: WO0178907A1] The invention concerns a method which consists in treating in an aqueous medium with a water soluble modifying (co)polymer having heat-sensitive properties, in particular a LCST between 3 and 100 DEG C. The method consists in treating the substrate in an aqueous medium by the heat-sensitive modifying (co)polymer at a temperature not less than the LCST of the heat-sensitive (co)polymer to precipitate the latter onto the substrate while it is being treated on account of its hydrophobic character in this temperature domain. In the case where the substrate to be treated cannot be subjected to temperature exceeding a value T, the method consists in treating the substrate in an aqueous medium at a temperature < T, the water soluble and heat-sensitive (co)polymer being then selected among those having a LCST not higher than treatment temperature. In the case where the substrate is treated in an aqueous medium at a temperature not higher than the LCST of the water soluble heat-sensitive (co)polymer, the (co)polymer is selected among those having functional, ionic or compatibility units enabling to fix it on the substrate.

IPC 1-7
B05D 5/00; C09D 5/02; C09D 171/02

IPC 8 full level
C08G 65/332 (2006.01); **C08L 71/02** (2006.01); **C09D 101/28** (2006.01); **C09D 133/14** (2006.01); **D06M 15/05** (2006.01); **D06M 15/263** (2006.01); **D06M 15/267** (2006.01); **D06M 15/27** (2006.01); **D06M 15/285** (2006.01); **D06M 15/31** (2006.01); **D06M 15/327** (2006.01); **D06M 15/347** (2006.01); **D06M 15/356** (2006.01)

CPC (source: EP)
C08G 65/3322 (2013.01); **C08L 71/02** (2013.01); **C09D 101/284** (2013.01); **C09D 133/14** (2013.01); **D06M 15/05** (2013.01); **D06M 15/263** (2013.01); **D06M 15/267** (2013.01); **D06M 15/27** (2013.01); **D06M 15/285** (2013.01); **D06M 15/31** (2013.01); **D06M 15/327** (2013.01); **D06M 15/347** (2013.01); **D06M 15/3562** (2013.01); **D06M 15/3564** (2013.01); **D06M 15/3566** (2013.01); **D06M 15/3568** (2013.01); **D06M 2200/00** (2013.01)

Citation (search report)
See references of WO 0178907A1

Cited by
CN107216430A; CN109487561A

Designated contracting state (EPC)
AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE TR

DOCDB simple family (publication)
WO 0178907 A1 20011025; AU 4850001 A 20011030; EP 1412097 A1 20040428; FR 2807771 A1 20011019

DOCDB simple family (application)
FR 0101075 W 20010409; AU 4850001 A 20010409; EP 01921523 A 20010409; FR 0004695 A 20000412